

Appl. No. 10/015,374
Amdt. dated March 7, 2005
Reply to Office Action of December 14, 2004

2826
JPLW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Kwang Seok Oh et al.

Assignee: Amkor Technology, Inc.

Title: STACKING STRUCTURE OF SEMICONDUCTOR CHIPS AND
SEMICONDUCTOR PACKAGE USING IT

Serial No.: 10/015,374 Filed: December 12, 2001

Examiner: Alexander O. Williams Group Art Unit: 2826

Docket No.: GK0020

Monterey, CA
March 7, 2005

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Dear Sir:

In response to the Office Action dated December 14, 2004,
please amend the above-identified application as follows:

1. **Amendments to the Claims** are reflected in the
listing of Claims which begins on page 2 of this paper;
and
2. **Remarks** begin on page 10 of this paper.